ASSOCIATION ELECTRONICS	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rigin international and Pan-American copyright conventions			all rights reserved und	der both	This docume level parts, the	ent is a declaration	s a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower eclaration encompasses all lower level materials for which the manufacturer has engineering responsibility.							
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and N	ials and Mfg Information			
Supplier	Information														
Company name* Company uniq				que ID			Unique ID Authority				Respon	Response Date*			
onsemi											2025-0	2025-06-24			
Contact Na	ame	Title - Contact			1	Phone - Contact*				Email - Contact*					
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized	l Representative*	Title - Representative			]	Phone - Representative*				Email - Representative*					
Product-E	Inv-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Ite		n Number Mfr Item Name				Effective Date Version Manufactu		Manufacturing Site		Weight*	UOM	Unit Type		
		NCV7321D11R2G Improved LIN Tra		Improved LIN Tran	sceiver	2025-06-24			PH1			81.78	mg	Each	
Manufac	cturing Proccess Informa	ntion						,					,		
	Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Tempera		ture Max Time at Peak Temper		ture Nun	nber of Reflow Cyc	les		
Matte Tin (Sn) - annealed			CU Alloy 2			260	C		30	seconds 3					
Comments															
TTENTI	ON: MSL 2 Rated item requir	es Dry Pack (a	fter electrical	test)											
or more i	nformation regarding materia	composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a							
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Sta										
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.89	mg	Supplier	Silicon (Si)	7440-21-3		3.89	mg
Die Attach	1.25	mg		Resin	proprietary data		0.1	mg
			Supplier	Silver (Ag)	7440-22-4		1.0563	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0937	mg
Lead Frame	29.12	mg	Supplier	Zinc (Zn)	7440-66-6		0.0291	mg
			Supplier	Iron (Fe)	7439-89-6		0.6698	mg
			Supplier	Copper (Cu)	7440-50-8		28.392	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0291	mg
Mold Compound-Black	46.29	mg		Epoxy resin	proprietary data		2.3145	mg
			Supplier	Phenolic Resin	Proprietary Data		2.3145	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.9258	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2315	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.5037	mg
Plating	0.96	mg	Supplier	Tin (Sn)	7440-31-5		0.96	mg
Wire Bond - Au	0.27	mg	Supplier	Gold (Au)	7440-57-5		0.27	mg